

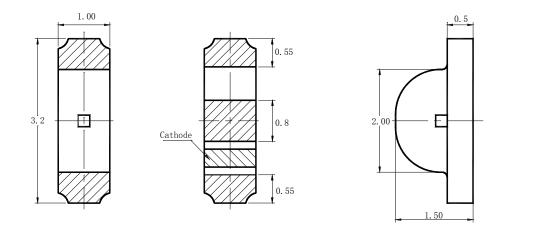
Features

- 3.2mm*1.5mm SMT LED, Super thin (1.0H mm)
- Low Power Consumption
- Wide Viewing Angle
- Various Colors
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow and wave solder process.
- Meet ROHS Green Product

Applications

• Backlight and Indicator

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.2 mm (.0079") unless otherwise noted.
- 3. Specifications are subject to change without notice
- 4. This drawing is only for reference, not as a basis for the actual structure.

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Form No: Approved By: Rev: V.1 Prepared By: Sales@FantasyLeds.com

FSL-3215100R-KASNL1R2WTH

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FSL-3215100R-KASNL1R2WTH

Selection Guide

Part No	Lens Type	Dice	Emitted Color
FSL-3215100R-KASNL1R2WTH	Water Clear	AllnGaP	Super Red

Electrical / Optical Characteristics At Ta=25 °C

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Condition
Iv	Luminous Intensity		15		mcd	IF=20mA
201/2	2 Viewing Angle		130		deg	IF=20mA
入 Peak	Peak Emission Wavelength		660		nm	IF=20mA
入d	d Dominant Wavelength		640		nm	IF=20mA
$ ext{ } \Delta \lambda$	Spectral Line Half-Width		20		nm	IF=20mA
VF	Forward Voltage	1.7	1.9	2.4	V	IF=20mA
IR	Reverse Current			10	μA	VR=5V

Note:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 optical centerline value

Absolute Maximum Ratings At Ta=25℃

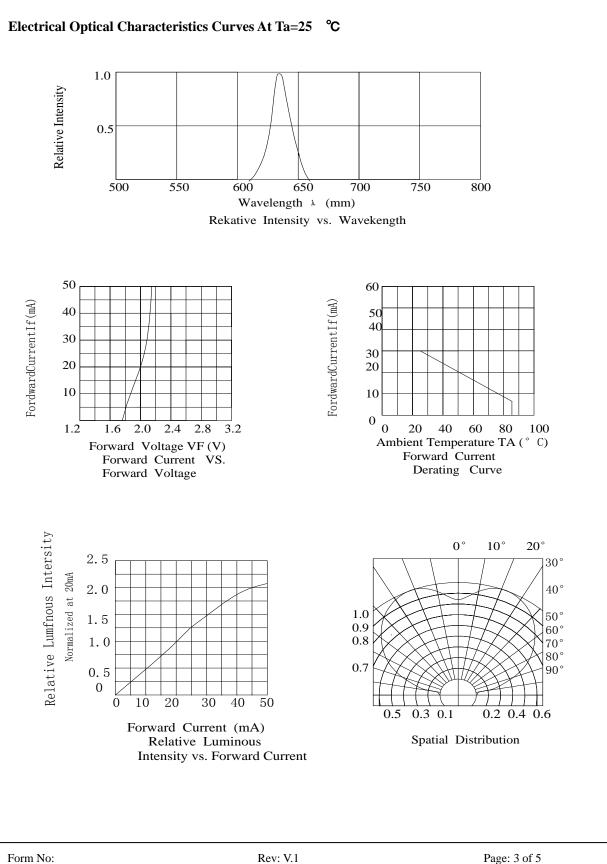
Parameter	Super Red	Unit	
Power Dissipation	75	mW	
Peak Forward Current[1]	80	mA	
Continuous Forward Current	30	mA	
Dreading Linear From25°C	0.4	mA/°C	
Reverse Voltage	5	V	
Operating Temperature Range	-55°C to + 85°C		
Storage Temperature Range	-55°C to +85°C		
Soldering Condition	260°C For5 Seconds		

Note:

1. 1/10DutyCycle, 0.1msPulseWidth



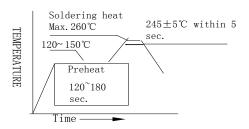
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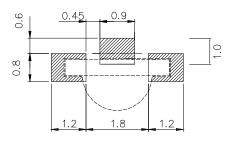
SMT Reflow Soldering Instructions



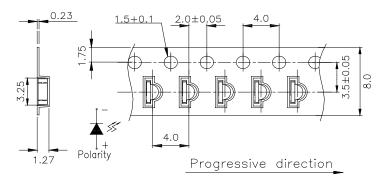
Notes:

- 1. Selles gives no other assurances regarding the ability of to withstand ESD. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 2. Reflow soldering should not be done more than two times.
- 3. Do not stress LED when soldering, and do not warp the circuit board after soldering
- 4. While using Iron, Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work should be finished within 2 sec under 320°C for once only.

Recommended Soldering Pad Dimensions



Package Specifications (Units: mm (inches))



Notes:

- 1. The LEDs should be used within a year.
- 2. The LEDs should be kept in $5 \sim 30^{\circ}$ C and 60% RH for less.
- 3. The LEDs should be used within 24 hours, or else should be kept in 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.



Reliability Test Items Conditions

FSL-3215100R-KASNL1R2WTH

Classification	Test Item	Test Conditions	Test hours	Result
Endurance Test	Operation Life	Connect with a power if=20mA Ta=Under room temperature	1000Hrs	0/20
	High Temperature High Humidity	Ta=+65 °C±5 °C RH=90%-95%	240Hrs	0/20
	High Temperature Storage	High Ta= $+85^{\circ}$ C $\pm 5^{\circ}$ C	1000Hrs	0/20
	Low Temperature Storage	Low Ta=-35°C±5°C Test time=1000hrs	1000Hrs	0/20
Environmental Test	Temperature Cycling	-45°C∼+105°C 15min 5min 15min	300 Cycles	0/20
	Thermal Shock	-35°C∼±5°C∼+85°C∼±5°C 5min 10sec 5min	300 Cycles	0/20
	Solder Resistance	Preheating: 120°C-150°C,within 2 minutes. Operation heating : 260°C(Max.),within5 seconds(Max.)	5Cycles	0/20

Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	VF(V)	IF=20mA	Over U×1.2
Reverse current	Ir(µA)	Vr=5V	Over U×2
Luminous intensity	Iv(mcd)	IF=20mA	Below S×0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Meansurment shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.